# OMRON Tactile Switch (SMD Type)

# **B3FS**

# Surface-mounting Switches Ideal for High-density Mounting

- Tape packing style also available.
- Allows reflow soldering.
- Incorporates a snap-action contact mechanism that ensures sharp switching operations.



# **Ordering Information**

### Model Number Legend



1 2 3 4 5

- 1. Size
  - 1: 6 mm x 6 mm
- 2. Ground Terminal
- 0: None
- 3. Height

### 0: 3.1 mm

### List of Models

Model	Plunger type	Operating force (OF)	Bag (see note 1)	Embossed tape (see note 2)
6 x 6 mm B3ES-1000 models	x 6 mm 3ES-1000 models	0.98 N {100 gf}	B3FS-1000	B3FS-1000P
		1.47 N {150 gf}	B3FS-1002	B3FS-1002P

Note: 4. Orders must be made in units of 100 pieces.

5. Orders must be made in units of 3,000 pieces. For the packing style, refer to Switch Packing on page 13.

#### 4. Operating Force (OF)

- 0: 100 gf
- 2: 150 gf
- 5. Shipment Package
  - None: Bag
    - P: Embossed tape

# Specifications -

### Ratings/Characteristics

Switching capacity	50 mA, 24 VDC (resistive load)
Contact configuration	SPST-NO
Contact material	Silver plating
Contact resistance	100 m $\Omega$ max. (initial value) (rated: 1 mA, 5 VDC)
Insulation resistance	100 MΩ min. (at 100 VDC)
Dielectric strength	250 VAC, 50/60 Hz for 1 min
Bounce time	5 ms max.
Vibration resistance	Malfunction: 10 to 55 Hz, 1.5-mm double amplitude
Shock resistance	Destruction: 1,000 m/s <sup>2</sup> {approx. 100G} max. Malfunction: 100 m/s <sup>2</sup> {approx. 10G} max.
Life expectancy	Standard models: 1,000,000 operations min. High-force models: 300,000 operations min.
Ambient temperature	Operating: –40°C to 85°C (with no icing)
Ambient humidity	Operating: 35% to 85%
Weight	B3F-1000: Approx. 0.2 g

### Engineering Data

### **Operating Force vs. Stroke Characteristics**



### Dimensions

Note: All units are in millimeters unless otherwise indicated. Unless otherwise specified, a tolerance of ±0.4 mm applies to all dimensions.

B3FS-1000 B3FS-1002 B3FS-1000P B3FS-1002P



#### **Operating Characteristics**

Item	B3FS-1□□0	B3FS-1□□2
Operating force (OF)	0.98±0.29 N {100±30 gf}	1.47±0.49 N {150±50 gf}
Releasing force (RF)	0.2 N {20 gf} min.	0.49 N {50 gf} min.
Pretravel (PT)	0.25 <sup>+0.2</sup> <sub>-0.1</sub> mm	

## Precautions

#### Operation

Do not repeatedly operate the Switch with excessive force. Applying excessive pressure or applying additional force after the plunger has stopped may deform the disc spring of the Switch, resulting in malfunction.

Be sure to set up the Switch so that the plunger will operate in a straight vertical line. A decrease in the life of the Switch may result if the plunger is pressed off-center or from an angle.



The Switches are not sealed and should be protected with a resin sheet as shown below when used in dust-prone environments



#### B3FS

#### Soldering

Do not apply flow soldering, otherwise fragments of solder and flux may have a bad influence on the operation of the pushbutton.

Apply reflow soldering according to the optimum heating curve shown below. Reflow soldering equipment may have a high peak value. Be sure to conduct a test before use.

Soldering may be repeated only once at a minimum interval of five minutes if the Switch is not soldered properly.

The flux should not be removed or rinsed off after soldering. Doing so may cause flux or dust on PCBs to get inside the Switch, resulting in malfunction.



**Note:** The above curve is given on condition that the thickness of the PCB is 1.6 mm.

#### Switch Packing

Switches are packed on tape as shown below.



Tape drawing direction

Package	3,000 Switches
Heat resistance	50°C for 24 hours (not be deformed)

ALL DIMENSIONS SHOWN ARE IN MILLIMETERS. To convert millimeters into inches, multiply by 0.03937. To convert grams into ounces, multiply by 0.03527.

Cat. No. A113-E1-1A